

**7580D** (文件编号: S&CIC1692)

## N-Channel Trench Power MOSFET

### General Description

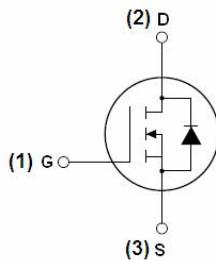
The 7580D is N-channel MOS Field Effect Transistor designed for high current switching applications. Rugged E<sub>AS</sub> capability and ultra low R<sub>DS(ON)</sub> is suitable for PWM, load switching especially for E-Bike controller applications.

### Features

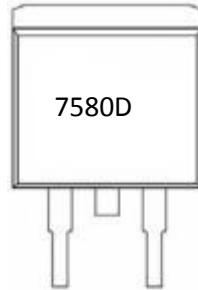
- V<sub>DS</sub>=75V; I<sub>D</sub>=86A@ V<sub>GS</sub>=10V;
- R<sub>DS(ON)</sub><8.5mΩ @ V<sub>GS</sub>=10V
- Special Designed for E-Bike Controller Application
- Ultra Low On-Resistance
- High UIS and UIS 100% Test

### Application

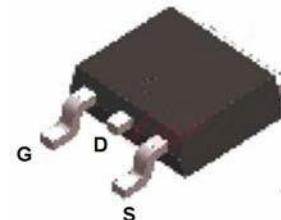
- 64V E-Bike Controller Applications
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Schematic diagram



Marking and pin assignment



TO-263top view

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
7580D	7580D	TO-263	-	-	-

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0V)	75	V
V <sub>GS</sub>	Gate-Source Voltage (V <sub>DS</sub> =0V)	±20	V
I <sub>D(DC)</sub>	Drain Current (DC) at T <sub>c</sub> =25°C	86	A
I <sub>D(DC)</sub>	Drain Current (DC) at T <sub>c</sub> =100°C	60.4	A
I <sub>DM (pulse)</sub>	Drain Current-Continuous@ Current-Pulsed <sup>(Note 1)</sup>	368	A
dV/dt	Peak Diode Recovery Voltage	7.3	V/ns
P <sub>D</sub>	Maximum Power Dissipation(T <sub>c</sub> =25°C)	147	W
	Derating Factor	0.93	W/°C
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>(Note 2)</sup>	625	mJ
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 To 175	°C

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition:T<sub>J</sub>=25°C,VDD=40V,V<sub>BGB</sub>=10V,RG=25Ω

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**Table 2. Thermal Characteristic**

Symbol	Parameter	Value	Max	Unit
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	---	1.02	°C/W

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

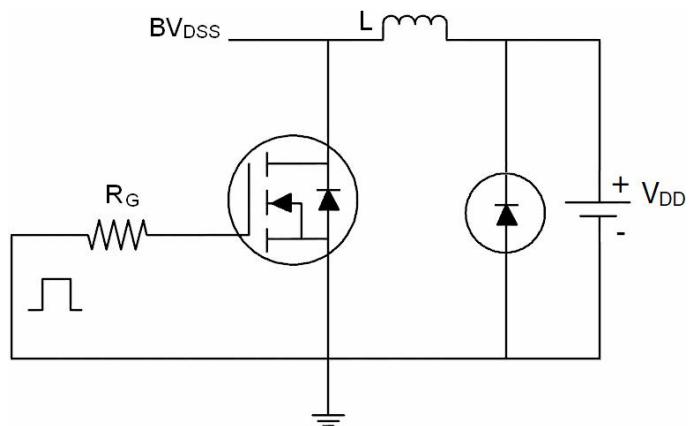
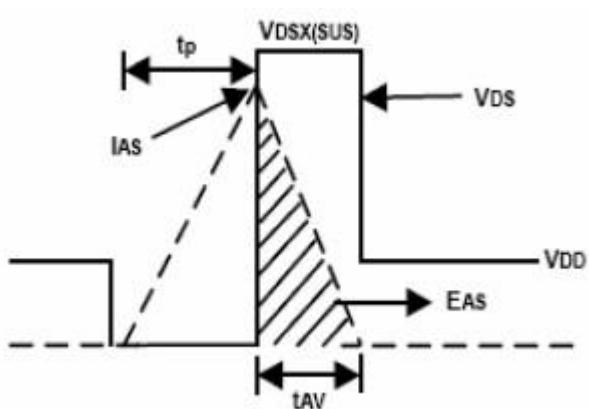
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	75			V
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )	$V_{DS}=75V, V_{GS}=0V$			1	$\mu A$
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=125^\circ C$ )	$V_{DS}=75V, V_{GS}=0V$			10	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$		7.0	8.5	$m\Omega$
<b>Dynamic Characteristics</b>						
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=15A$	20			S
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		5053		PF
$C_{oss}$	Output Capacitance			442		PF
$C_{rss}$	Reverse Transfer Capacitance			145		PF
$Q_g$	Total Gate Charge			115		nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=50V, I_D=40A, V_{GS}=10V$		20		nC
$Q_{gd}$	Gate-Drain Charge			50		nC
<b>Switching Times</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=30V, I_D=40A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$		23		nS
$t_r$	Turn-on Rise Time			51		nS
$t_{d(off)}$	Turn-Off Delay Time			66		nS
$t_f$	Turn-Off Fall Time			23		nS
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-drain Current(Body Diode)			86		A
$I_{SDM}$	Pulsed Source-Drain Current(Body Diode)			368		A
$V_{SD}$	Forward On Voltag (Note 1)	$T_J=25^\circ C, I_{SD}=40A, V_{GS}=0V$		0.89	0.99	V
$t_{rr}$	Reverse Recovery Tim (Note 1)	$T_J=25^\circ C, I_F=75A, di/dt=100A/\mu s$		41		nS
$Q_{rr}$	Reverse Recovery Charg (Note 1)			86		nC
$t_{on}$	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ )				

Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%,  $R_G=25\Omega$ , Starting  $T_J=25^\circ C$

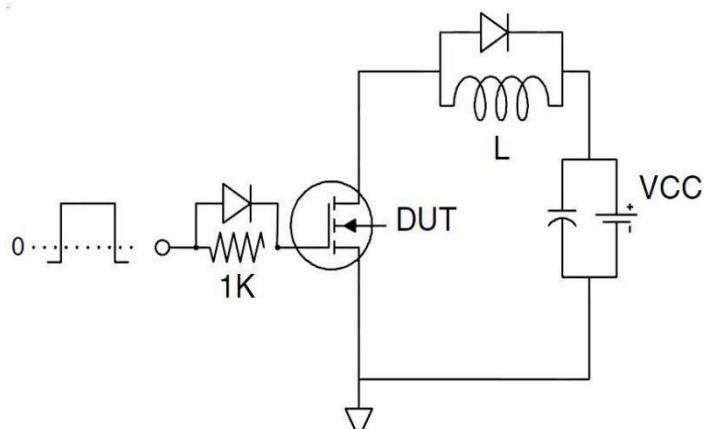
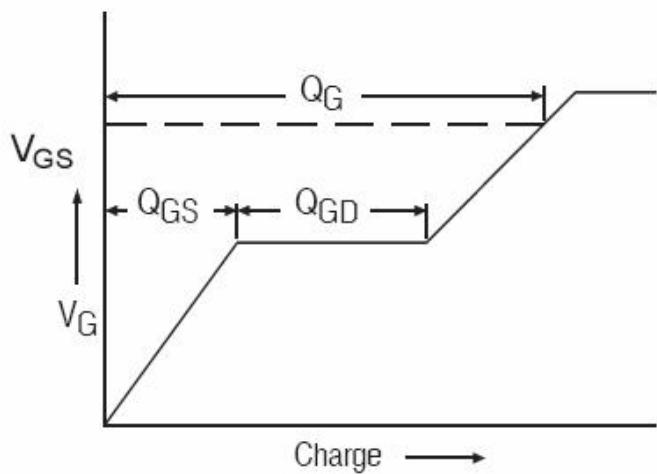


## Test Circuit

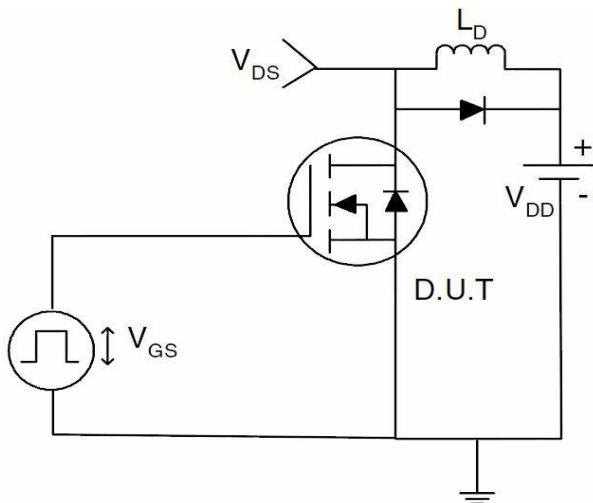
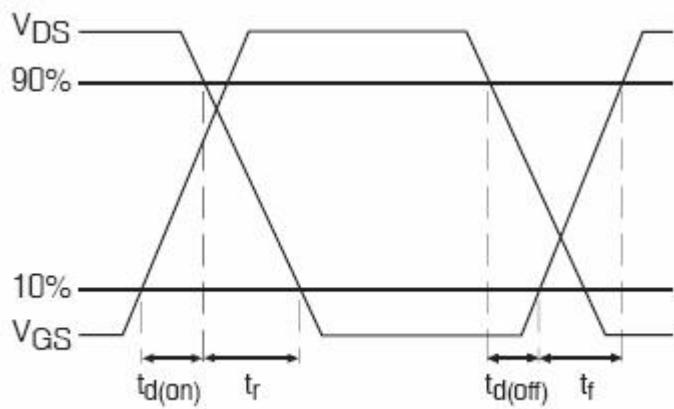
### 1) EAS Test Circuits



### 2) Gate Charge Test Circuit:



### 3) Switch Time Test Circuit:





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### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Figure1. Output Characteristics

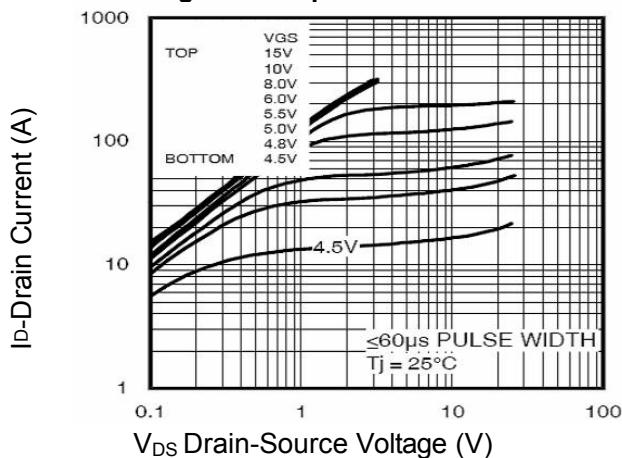


Figure2. Transfer Characteristics

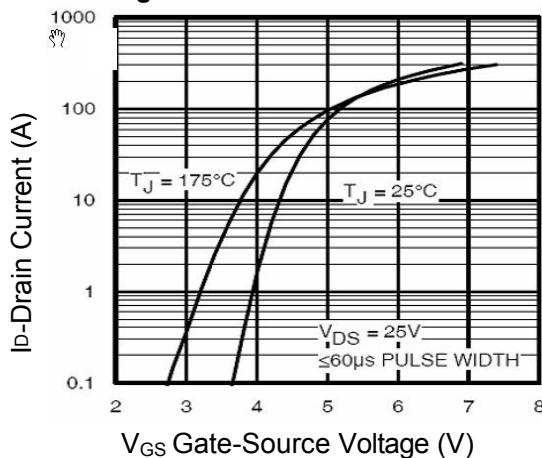


Figure3. BV<sub>DSS</sub> vs Junction Temperature

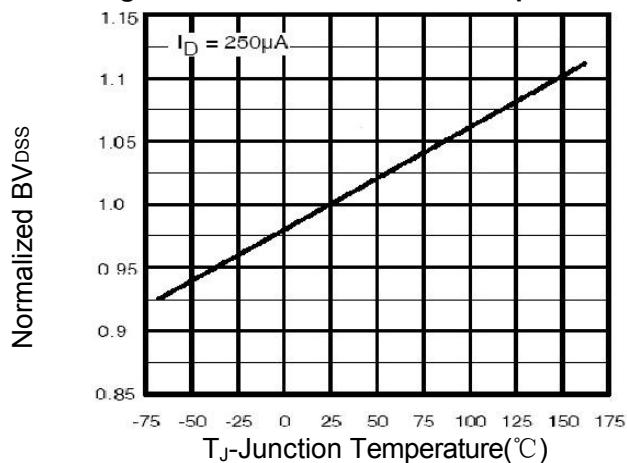


Figure4. ID vs Junction Temperature

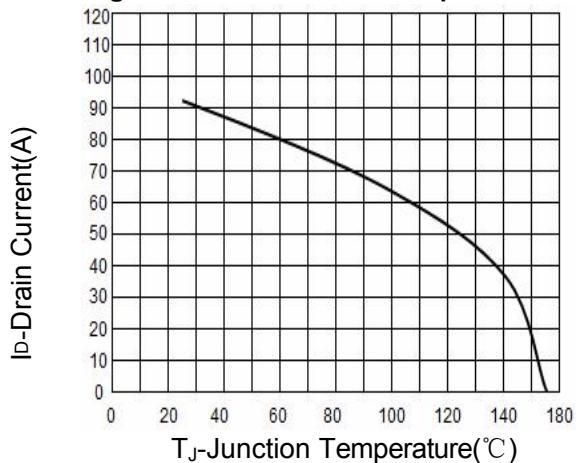


Figure5. V<sub>GS(th)</sub> vs Junction Temperature

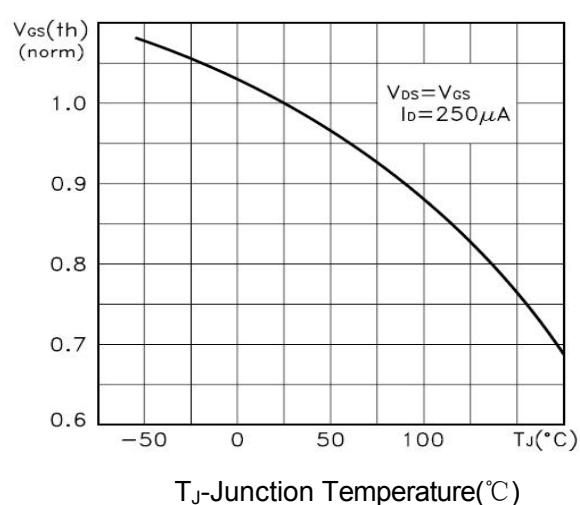
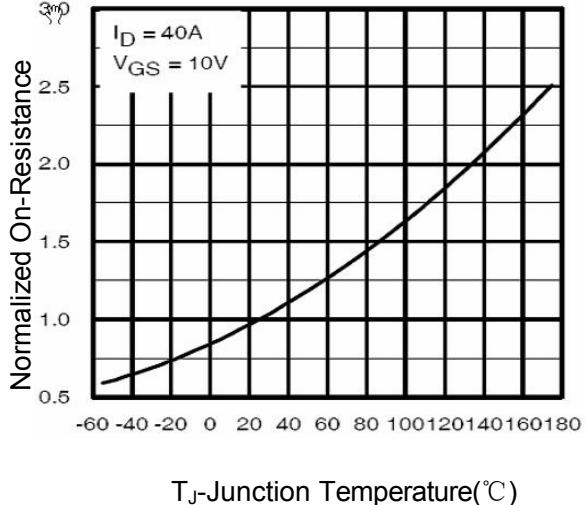


Figure6. R<sub>dson</sub> Vs Junction Temperature





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Figure7. Gate Charge

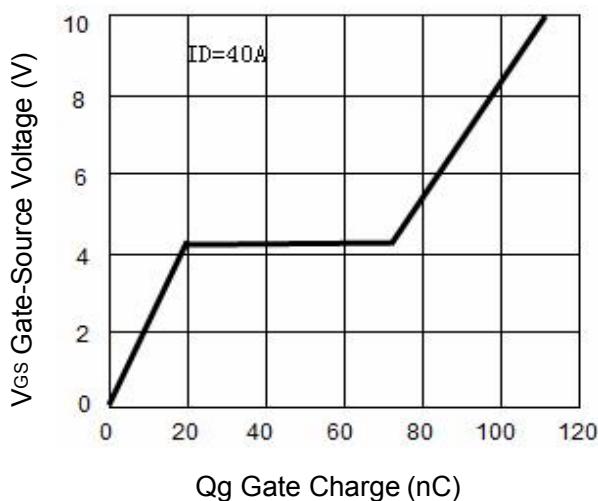


Figure8. Capacitance vs Vds

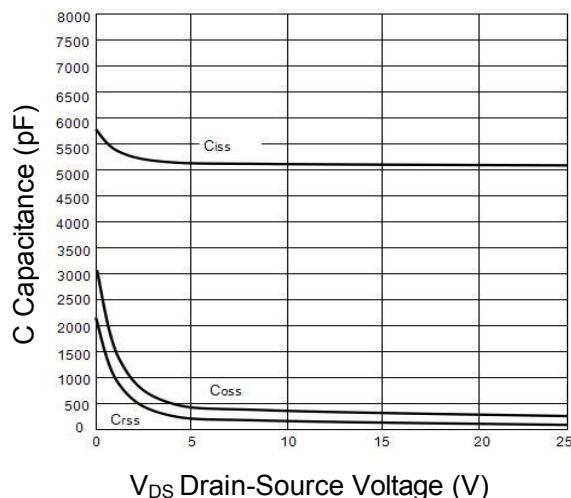


Figure9. Source- Drain Diode Forward

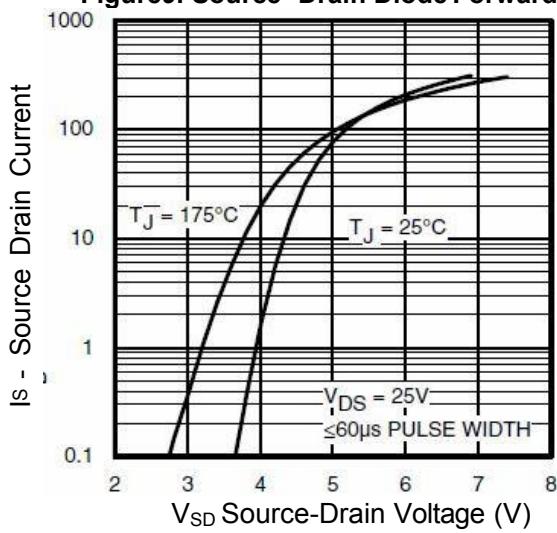


Figure10. Safe Operation Area

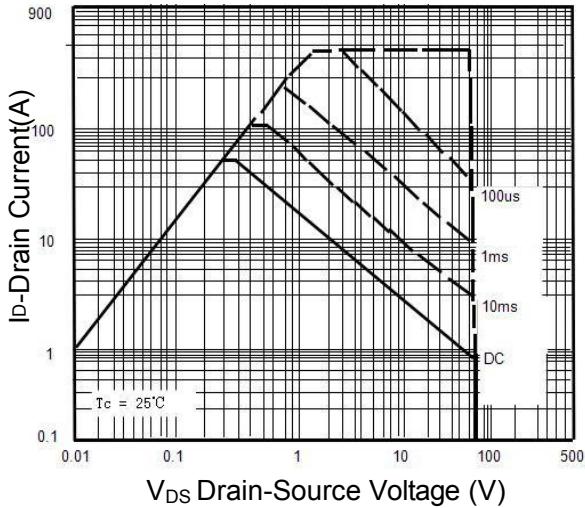
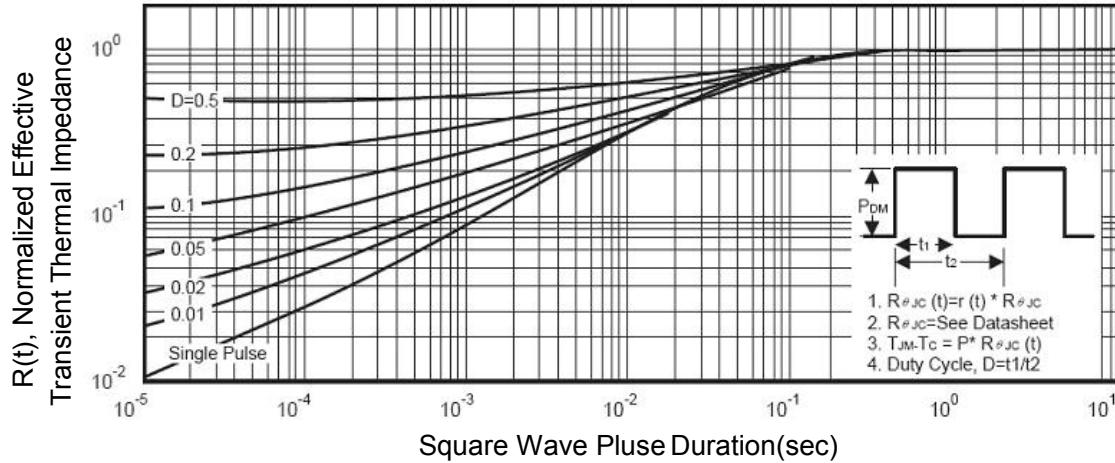
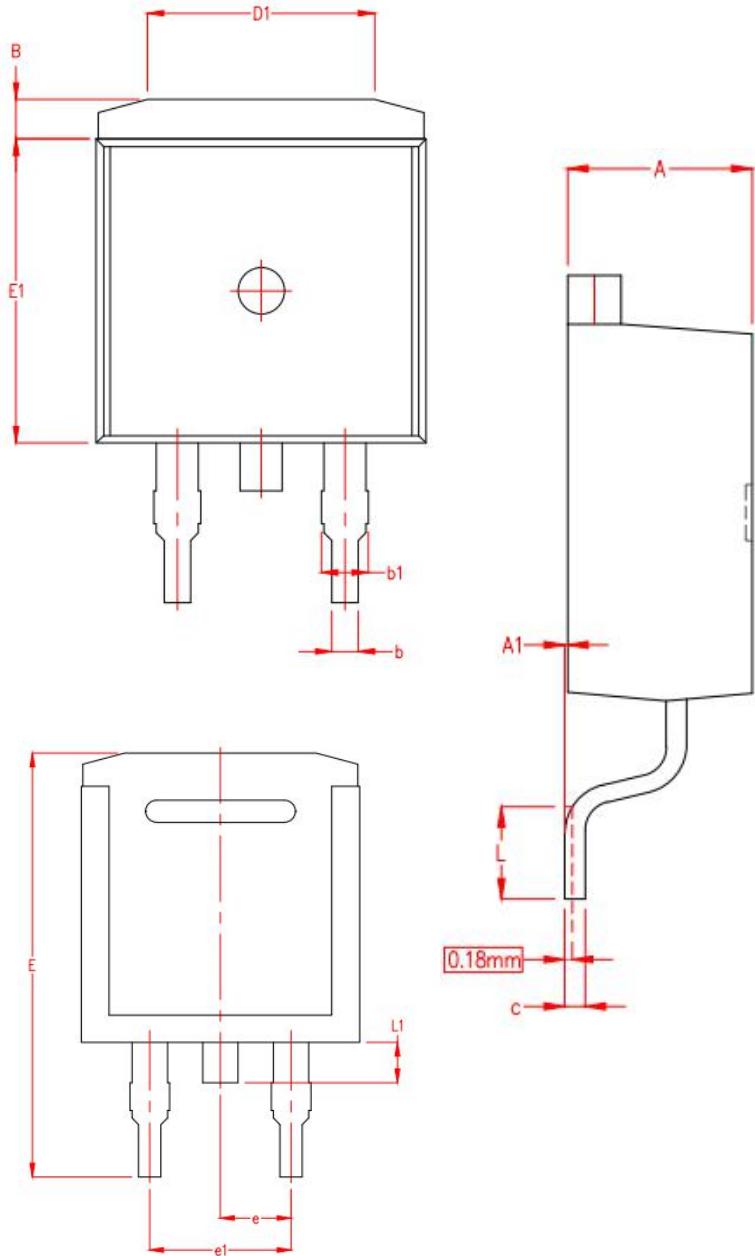


Figure11. Normalized Maximum Transient Thermal Impedance



### TO-263 Package Information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.45	4.50	4.55
A1	0	0.07	0.15
B	1.08	1.20	1.32
b	0.80TYP.		
b1	1.24	1.27	1.30
c	0.48	0.50	0.52
D	9.95	10.00	10.05
D1	6.89REF.		
E	15.09	15.24	15.39
E1	9.15	9.20	9.25
e	2.51	2.54	2.57
e1	5.05	5.08	5.11
L	2.29	2.54	2.79